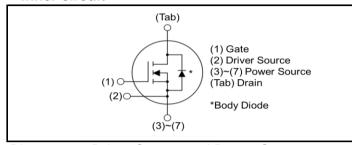


N-channel SiC power MOSFET

V_{DSS}	650V
R _{DS(on)} (Typ.)	60mΩ
$I_{D}^{^{*1}}$	38A
P_D	159W

Outline TO-263-7L (Tab)

•Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant

Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

Packaging specifications

	Packing	Embossed tape
	Reel size (mm)	330
Typo	Tape width (mm)	24
Type	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT3060AW7

● Absolute maximum ratings (T_a = 25°C)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		V_{DSS}	650	V
Continuous Drain current	T _c = 25°C	I _D *1	38	А
Continuous Drain current	T _c = 100°C	I _D ^{*1}	27	А
Pulsed Drain current		I _{D,pulse} *2	95	А
Gate - Source voltage (DC)		V _{GSS}	-4 to +22	V
Gate - Source surge voltage (t _{surge} < 300ns)		V _{GSS_surge} *3	-4 to +26	V
Recommended drive voltage		$V_{GS_op}^{*4}$	0 / +18	V
Junction temperature		T _j	175	°C
Range of storage temperature		T _{stg}	-55 to +175	°C

●Electrical characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
		$V_{GS} = 0V$, $I_D = 1mA$				
Drain - Source breakdown voltage	V _{(BR)DSS}	$T_j = 25^{\circ}C$	650	-	-	V
voltago		T _j = -55°C	650	-	-	
		$V_{GS} = 0V, V_{DS} = 650V$				
Zero Gate voltage Drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	1	10	μΑ
Drain ourion		T _j = 150°C	-	2	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +22V, \ V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -4V$, $V_{DS} = 0V$	-	ı	-100	nA
Gate threshold voltage	V _{GS (th)}	$V_{DS} = 10V, I_D = 6.67 \text{mA}$	2.7	-	5.6	V
		$V_{GS} = 18V, I_D = 13A$				
Static Drain - Source on - state resistance	R _{DS(on)} *5	$T_j = 25^{\circ}C$	-	60	78	mΩ
		T _j = 150°C	-	86	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	12	-	Ω

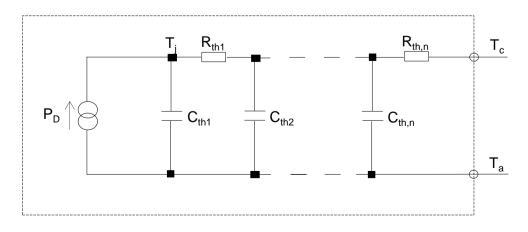
●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case*6	R _{thJC}	-	0.73	0.94	°C/W

● Typical Transient Thermal Characteristics

Symbol	Value	Unit
R _{th1}	1.14×10 ⁻¹	
R _{th2}	1.31×10 ⁻¹	K/W
R _{th3}	4.56×10 ⁻¹	

Symbol	Value	Unit
C_{th1}	2.18×10 ⁻³	
C_{th2}	3.70×10 ⁻²	Ws/K
C _{th3}	1.09×10 ⁻²	



●Electrical characteristics (T_a = 25°C)

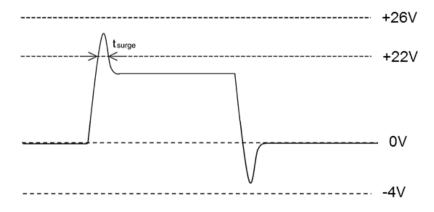
Davamatav	'	Conditions		Values		Unit
Parameter		Min.	Тур.	Max.		
Transconductance	g fs *5	$V_{DS} = 10V, I_{D} = 13A$	-	4.9	-	S
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	852	ı	
Output capacitance	C _{oss}	V _{DS} = 500V	-	55	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	24	ı	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 300V$	-	126	ı	pF
Total Gate charge	Qg *5	$V_{DS} = 300V$ $I_{D} = 13A$	-	58	ı	
Gate - Source charge	Q _{gs} *5	$V_{GS} = 18V$	-	11	ı	nC
Gate - Drain charge	Q _{gd} *5	See Fig. 1-1.	-	31	-	
Turn - on delay time	t _{d(on)} *5	$V_{DS} = 400V$ $I_{D} = 13A$	-	5	ı	
Rise time	t _r *5	$V_{GS} = 0V/+18V$	-	14	-	no
Turn - off delay time	t _{d(off)} *5	$R_G = 0\Omega, L = 750\mu H$ $L_{\sigma} = 50 nH, C_{\sigma} = 10 pF$	-	17	ı	ns
Fall time	t _f *5	See Fig. 2-1, 2-2, 2-3.	-	13	-	
Turn - on switching loss	E _{on} *5	E _{on} includes diode reverse recovery.	-	79	ı	1
Turn - off switching loss	E _{off} *5		-	18	-	μJ

●Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	onditions	Values	Unit	
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Body diode continuous, forward current	I _S *1	T _c = 25°C	-	-	38	А
Body diode direct current, pulsed	I _{SM} *2	11 _c = 23 0	ı	ı	95	А
Forward voltage	V _{SD} *5	$V_{GS} = 0V$, $I_D = 13A$	•	3.2	ı	V
Reverse recovery time	t _{rr} *5	$I_F = 13A$ $V_R = 400V$	ı	18	ı	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 2500A/µs	ı	294	ı	nC
Peak reverse recovery current	I _{rrm} *5	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	27	-	А

^{*1} Limited by maximum temperature allowed.

*3 Example of acceptable V_{GS} waveform



Please note especially when using driver source that $V_{\text{GSS_surge}}$ must be in the range of absolute maximum rating.

*4 Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.

*5 Pulsed

*6 The case is bottom of leadframe underneath the chip. Practial value of Rth(j-c) is influenced by design of the user. Discribed value is only vaild at the specific conditions such as JESD51-14.

^{*2} $P_W \le 10\mu s$, Duty cycle $\le 1\%$

Fig.1 Power Dissipation Derating Curve

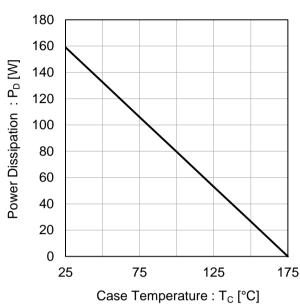


Fig.2 Maximum Safe Operating Area

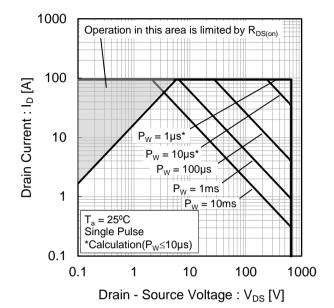
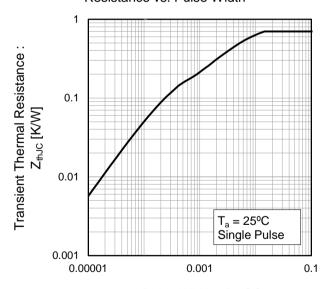


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



Pulse Width: P_W [s]

Fig.4 Typical Output Characteristics(I)

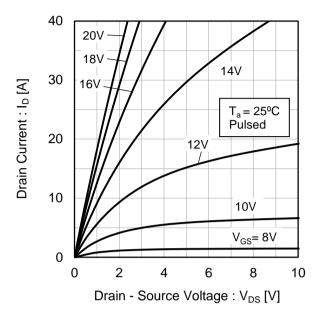


Fig.5 Typical Output Characteristics(II)

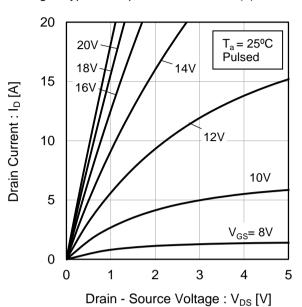


Fig.6 T_i = 25°C 3rd Quadrant Characteristics

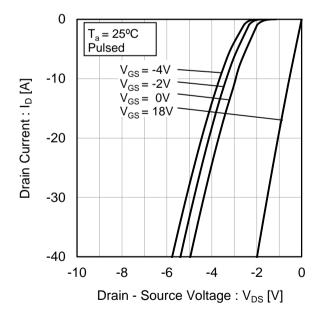


Fig.7 T_i = 150°C Typical Output Characteristics(I) 40 20V 14V 18V 16V 30 Drain Current: I_D [A] $T_a = 150^{\circ}C$ 12V 10V 20 10 $V_{GS} = 8V$ 0 2 4 0 6 10 Drain - Source Voltage : V_{DS} [V]

Fig.8 T_i = 150°C Typical Output

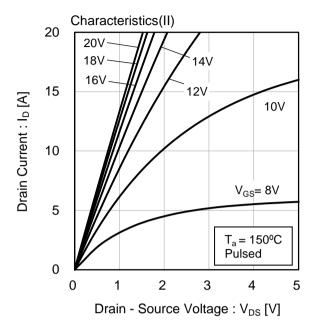


Fig.9 T_i = 150°C 3rd Quadrant Characteristics

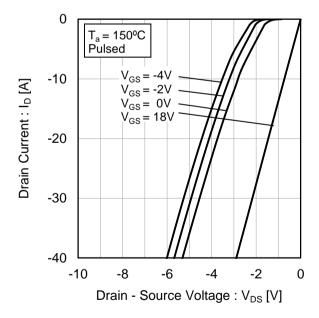


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage

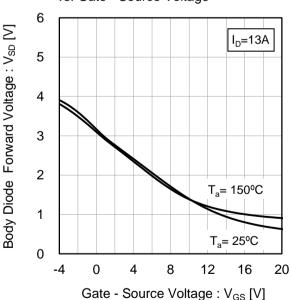


Fig.11 Typical Transfer Characteristics (I)

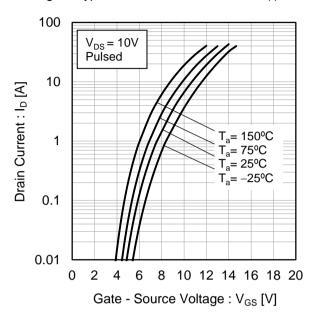


Fig.12 Typical Transfer Characteristics (II)

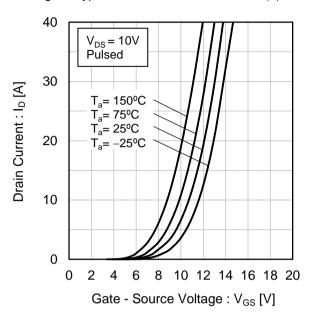


Fig.13 Gate Threshold Voltage vs. Junction Temperature

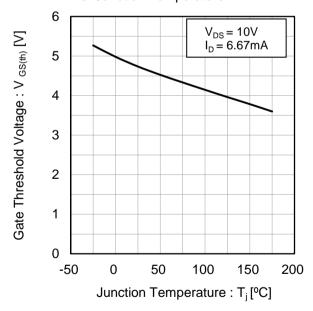
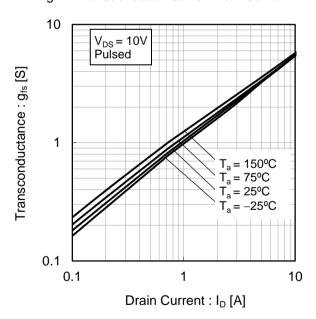
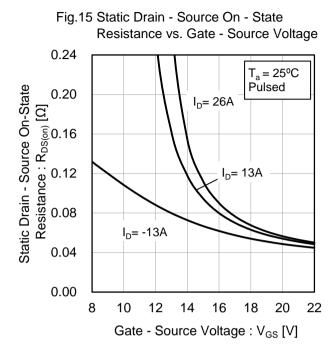


Fig.14 Transconductance vs. Drain Current

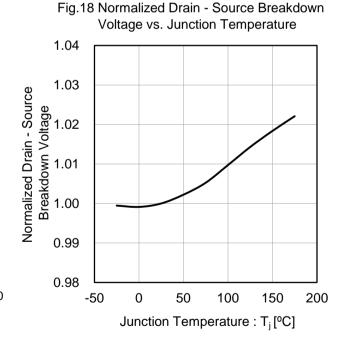




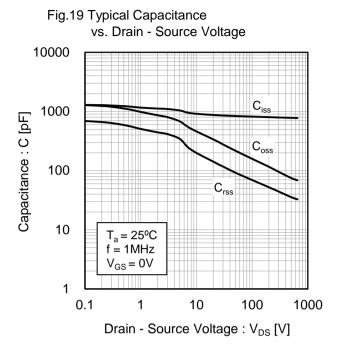
Resistance vs. Junction Temperature 0.12 $V_{GS} = 18V$ Pulsed Static Drain - Source On-State Resistance : $R_{DS(on)}[\Omega]$ 0.0 80.0 I_D= 26A $I_D = 13A$ $I_D = -13A$ 0.00 -50 0 50 100 150 200 Junction Temperature : T_i [°C]

Fig.16 Static Drain - Source On - State

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current 1 Static Drain - Source On-State Resistance: $R_{DS(on)} \left[\Omega \right]$ 0.1 = 150°C = 125°C = 75°C = 25°C $V_{GS} = 18V$ $T_a = -25^{\circ}C$ Pulsed 0.01 10 100 Drain Current: ID [A]



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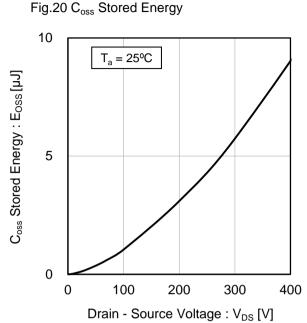
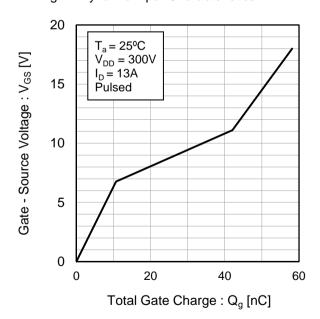


Fig.21 Dynamic Input Characteristics



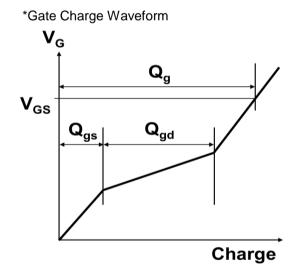


Fig.22 Typical Switching Time vs. External Gate Resistance

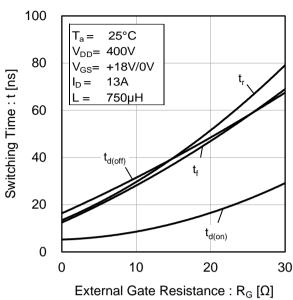


Fig.23 Typical Switching Loss vs. Drain - Source Voltage

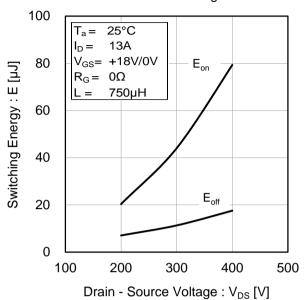


Fig.24 Typical Switching Loss

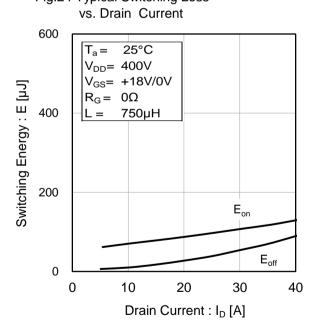
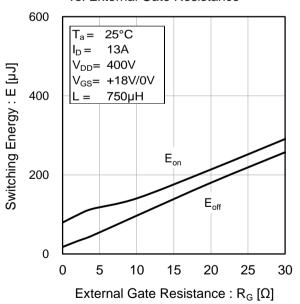


Fig.25 Typical Switching Loss vs. External Gate Resistance



Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

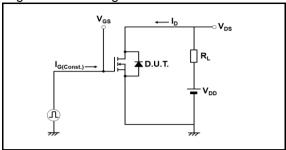
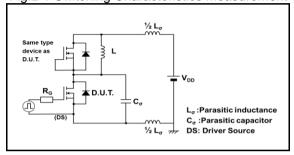


Fig.2-1 Switching Characteristics Measurement Circuit



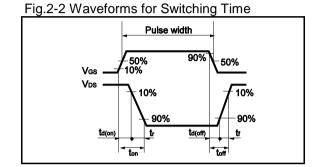


Fig.2-3 Waveforms for Switching Energy Loss

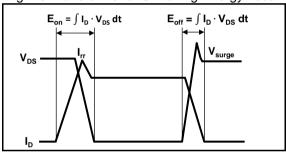


Fig.3-1 Reverse Recovery Time Measurement Circuit

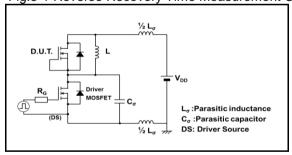
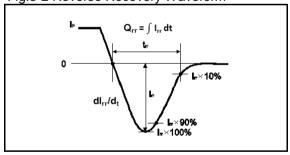


Fig.3-2 Reverse Recovery Waveform



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